



## CST4030 N-Ch and P-Ch Fast Switching MOSFETs

- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

### CST4030 Product Summary



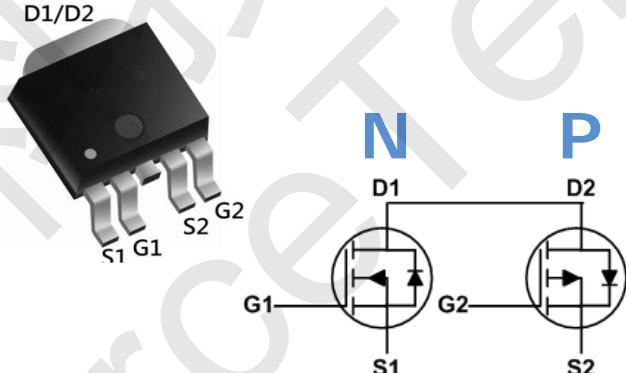
| BVDSS | RDS(on) | ID   |
|-------|---------|------|
| 40V   | 13.5mΩ  | 30A  |
| -40V  | 25mΩ    | -30A |

### CST4030 Description

The CST4030 is the high performance complementary N-ch and P-ch MOSFETs with high cell density, which provide excellent RDS(on) and gate charge for most of the synchronous buck converter applications.

The CST4030 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

### CST4030 TO252-4L Pin Configuration



### CST4030 Absolute Maximum Ratings

| Symbol                                | Parameter  | Rating     |            | Units |
|---------------------------------------|--|------------|------------|-------|
|                                       |  | N-Ch       | P-Ch       |       |
| V <sub>DS</sub>                       | Drain-Source Voltage   | 40         | -40        | V     |
| V <sub>GS</sub>                       | Gate-Source Voltage  | ±20        | ±20        | V     |
| I <sub>D</sub> @T <sub>c</sub> =25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 30         | -30        | A     |
| I <sub>D</sub> @T <sub>c</sub> =100°C | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 18         | -16        | A     |
| I <sub>DM</sub>                       | Pulsed Drain Current <sup>2</sup>                            | 60         | -60        | A     |
| EAS                                   | Single Pulse Avalanche Energy <sup>3</sup>                   | 28         | 40.9       | mJ    |
| I <sub>AS</sub>                       | Avalanche Current  | 27         | -27        | A     |
| P <sub>D</sub> @T <sub>c</sub> =25°C  | Total Power Dissipation <sup>4</sup>                         | 25         | 35         | W     |
| T <sub>STG</sub>                      | Storage Temperature Range                                    | -55 to 150 | -55 to 150 | °C    |
| T <sub>J</sub>                        | Operating Junction Temperature Range                         | -55 to 150 | -55 to 150 | °C    |

### CST4030 Thermal Data

| Symbol           | Parameter  | Typ. | Max. | Unit |
|------------------|--|------|------|------|
| R <sub>θJA</sub> | Thermal Resistance Junction-Ambient <sup>1</sup> | ---  | 62   | °C/W |
| R <sub>θJC</sub> | Thermal Resistance Junction-Case <sup>1</sup>    | ---  | 3.6  | °C/W |



CST4030 N-Ch and P-Ch Fast Switching MOSFETs

**CST4030 N-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise specified)**

| Symbol                                     | Parameter  | Conditions   | Min. | Typ.  | Max.      | Unit                       |
|--|--|--|------|-------|-----------|----------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain-Source Breakdown Voltage                     | $V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=250\mu\text{A}$  | 40   | ---   | ---       | V                          |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | BVDSS Temperature Coefficient                      | Reference to $25^\circ\text{C}$ , $I_{\text{D}}=1\text{mA}$  | ---  | 0.032 | ---       | $\text{V}/^\circ\text{C}$  |
| $R_{\text{DS}(\text{ON})}$                 | Static Drain-Source On-Resistance <sup>2</sup>     | $V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=15\text{A}$   | ---  | 13.5  | 18        | $\text{m}\Omega$           |
|  |  | $V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=10\text{A}$  | ---  | 18.4  | 24        |                            |
| $V_{\text{GS}(\text{th})}$                 | Gate Threshold Voltage                             | $V_{\text{GS}}=V_{\text{DS}}$ , $I_{\text{D}}=250\mu\text{A}$  | 1.2  | 1.6   | 2.5       | V                          |
| $\Delta V_{\text{GS}(\text{th})}$          | $V_{\text{GS}(\text{th})}$ Temperature Coefficient |  | ---  | -4.8  | ---       | $\text{mV}/^\circ\text{C}$ |
| $I_{\text{DSS}}$                           | Drain-Source Leakage Current                       | $V_{\text{DS}}=32\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$                        | ---  | ---   | 1         | $\mu\text{A}$              |
|  |  | $V_{\text{DS}}=32\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=55^\circ\text{C}$                        | ---  | ---   | 5         |                            |
| $I_{\text{GSS}}$                           | Gate-Source Leakage Current                        | $V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$   | ---  | ---   | $\pm 100$ | nA                         |
| $g_{\text{fs}}$                            | Forward Transconductance                           | $V_{\text{DS}}=5\text{V}$ , $I_{\text{D}}=15\text{A}$  | ---  | 34    | ---       | S                          |
| $R_g$                                      | Gate Resistance                                    | $V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$                                | ---  | 2.1   | ---       | $\Omega$                   |
| $Q_g$                                      | Total Gate Charge (4.5V)                           | $V_{\text{DS}}=32\text{V}$ , $V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=15\text{A}$                   | ---  | 10    | ---       | nC                         |
| $Q_{\text{gs}}$                            | Gate-Source Charge                                 |  | ---  | 2.55  | ---       |                            |
| $Q_{\text{gd}}$                            | Gate-Drain Charge                                  |  | ---  | 4.8   | ---       |                            |
| $T_{\text{d}(\text{on})}$                  | Turn-On Delay Time                                 | $V_{\text{DD}}=20\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_g=3.3\Omega$<br>$I_{\text{D}}=15\text{A}$ | ---  | 2.8   | ---       | ns                         |
| $T_r$                                      | Rise Time  |  | ---  | 12.8  | ---       |                            |
| $T_{\text{d}(\text{off})}$                 | Turn-Off Delay Time                                |  | ---  | 21.2  | ---       |                            |
| $T_f$                                      | Fall Time  |  | ---  | 6.4   | ---       |                            |
| $C_{\text{iss}}$                           | Input Capacitance                                  | $V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$                               | ---  | 1013  | ---       | pF                         |
| $C_{\text{oss}}$                           | Output Capacitance                                 |  | ---  | 107   | ---       |                            |
| $C_{\text{rss}}$                           | Reverse Transfer Capacitance                       |  | ---  | 76    | ---       |                            |
| $I_s$                                      | Continuous Source Current <sup>1,5</sup>           | $V_G=V_D=0\text{V}$ , Force Current  | ---  | ---   | 40        | A                          |
| $I_{\text{SM}}$                            | Pulsed Source Current <sup>2,5</sup>               |  | ---  | ---   | 85        | A                          |
| $V_{\text{SD}}$                            | Diode Forward Voltage <sup>2</sup>                 | $V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=1\text{A}$ , $T_J=25^\circ\text{C}$                          | ---  | ---   | 1.2       | V                          |
| $t_{\text{rr}}$                            | Reverse Recovery Time                              | $I_f=15\text{A}$ , $di/dt=100\text{A}/\mu\text{s}$ ,<br>$T_J=25^\circ\text{C}$                         | ---  | 10    | ---       | nS                         |
| $Q_{\text{rr}}$                            | Reverse Recovery Charge                            |  | ---  | 3.1   | ---       | nC                         |

**Note :**

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$
- 3 .The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}=25\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $L=0.1\text{mH}$ , $I_{\text{AS}}=25\text{A}$
- 4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 5.The data is theoretically the same as  $I_{\text{D}}$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.



CST4030 N-Ch and P-Ch Fast Switching MOSFETs

**CST4030 P-Channel Electrical Characteristics ( $T_J=25^{\circ}\text{C}$ , unless otherwise noted)**

| Symbol                                     | Parameter                                      | Conditions   | Min. | Typ.  | Max.      | Unit                        |
|--|--|--|------|-------|-----------|-----------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain-Source Breakdown Voltage                 | $V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=-250\mu\text{A}$   | -40  | ---   | ---       | V                           |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | BV <sub>DSS</sub> Temperature Coefficient      | Reference to $25^{\circ}\text{C}$ , $I_{\text{D}}=-1\text{mA}$   | ---  | -0.02 | ---       | $\text{V}/^{\circ}\text{C}$ |
| $R_{\text{DS}(\text{ON})}$                 | Static Drain-Source On-Resistance <sup>2</sup> | $V_{\text{GS}}=-10\text{V}$ , $I_{\text{D}}=-8\text{A}$  | ---  | 25    | 32        | $\text{m}\Omega$            |
|  |  | $V_{\text{GS}}=-4.5\text{V}$ , $I_{\text{D}}=-4\text{A}$   | ---  | 32    | 46        |                             |
| $V_{\text{GS}(\text{th})}$                 | Gate Threshold Voltage                         | $V_{\text{GS}}=V_{\text{DS}}$ , $I_{\text{D}}=-250\mu\text{A}$   | -1.0 | ---   | -2.5      | V                           |
| $\Delta V_{\text{GS}(\text{th})}$          | V <sub>GS(th)</sub> Temperature Coefficient    |  | ---  | 3.72  | ---       | $\text{V}/^{\circ}\text{C}$ |
| $I_{\text{DSS}}$                           | Drain-Source Leakage Current                   | $V_{\text{DS}}=-32\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^{\circ}\text{C}$                               | ---  | ---   | 1         | $\text{uA}$                 |
|  |  | $V_{\text{DS}}=-32\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=55^{\circ}\text{C}$                               | ---  | ---   | 5         |                             |
| $I_{\text{GSS}}$                           | Gate-Source Leakage Current                    | $V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$   | ---  | ---   | $\pm 100$ | nA                          |
| $g_{\text{fs}}$                            | Forward Transconductance                       | $V_{\text{DS}}=-5\text{V}$ , $I_{\text{D}}=-8\text{A}$   | ---  | 10.7  | ---       | S                           |
| $Q_g$                                      | Total Gate Charge (-4.5V)                      | $V_{\text{DS}}=-15\text{V}$ , $V_{\text{GS}}=-4.5\text{V}$ , $I_{\text{D}}=-1\text{A}$                           | ---  | 11.5  | ---       | nC                          |
| $Q_{\text{gs}}$                            | Gate-Source Charge                             |  | ---  | 3.5   | ---       |                             |
| $Q_{\text{gd}}$                            | Gate-Drain Charge                              |  | ---  | 3.3   | ---       |                             |
| $T_{\text{d}(\text{on})}$                  | Turn-On Delay Time                             |  | ---  | 22    | ---       |                             |
| $T_r$                                      | Rise Time                                      | $V_{\text{DD}}=-15\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $R_{\text{G}}=3.3\Omega$ , $I_{\text{D}}=-1\text{A}$ | ---  | 15.7  | ---       | ns                          |
| $T_{\text{d}(\text{off})}$                 | Turn-Off Delay Time                            |  | ---  | 59    | ---       |                             |
| $T_f$                                      | Fall Time                                      |  | ---  | 5.5   | ---       |                             |
| $C_{\text{iss}}$                           | Input Capacitance                              |  | ---  | 1415  | ---       |                             |
| $C_{\text{oss}}$                           | Output Capacitance                             | $V_{\text{DS}}=-15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$  | ---  | 134   | ---       | pF                          |
| $C_{\text{rss}}$                           | Reverse Transfer Capacitance                   |  | ---  | 102   | ---       |                             |

**CST4030 Diode Characteristics**

| Symbol          | Parameter                                | Conditions   | Min. | Typ. | Max. | Unit |
|-----------------|--|--|------|------|------|------|
| $I_s$           | Continuous Source Current <sup>1,5</sup> | $V_G=V_D=0\text{V}$ , Force Current  | ---  | ---  | -30  | A    |
| $I_{\text{SM}}$ | Pulsed Source Current <sup>2,5</sup>     |  | ---  | ---  | -60  | A    |
| $V_{\text{SD}}$ | Diode Forward Voltage <sup>2</sup>       | $V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=-1\text{A}$ , $T_J=25^{\circ}\text{C}$ | ---  | ---  | -1.2 | V    |

Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}=-25\text{V}$ ,  $V_{\text{GS}}=-10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{\text{AS}}=-28.6\text{A}$
- 4.The power dissipation is limited by  $150^{\circ}\text{C}$  junction temperature
- 5.The data is theoretically the same as  $I_{\text{D}}$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.



CST4030 N-Ch and P-Ch Fast Switching MOSFETs

CST4030 N-Channel Typical Characteristics

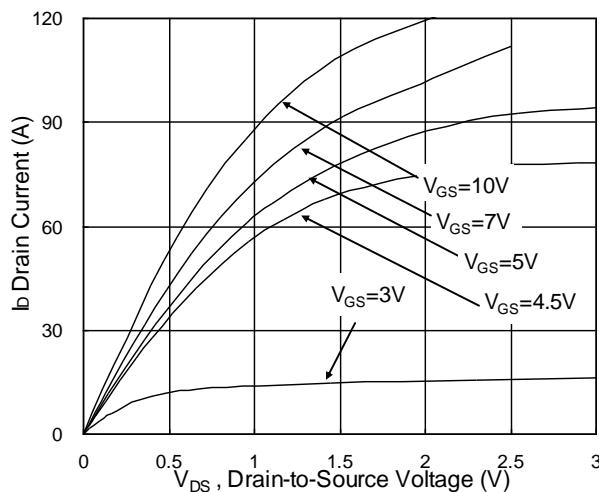


Fig.1 Typical Output Characteristics

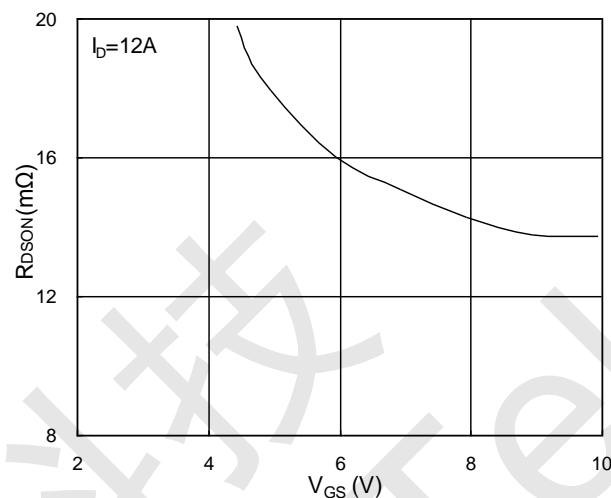


Fig.2 On-Resistance vs. G-S Voltage

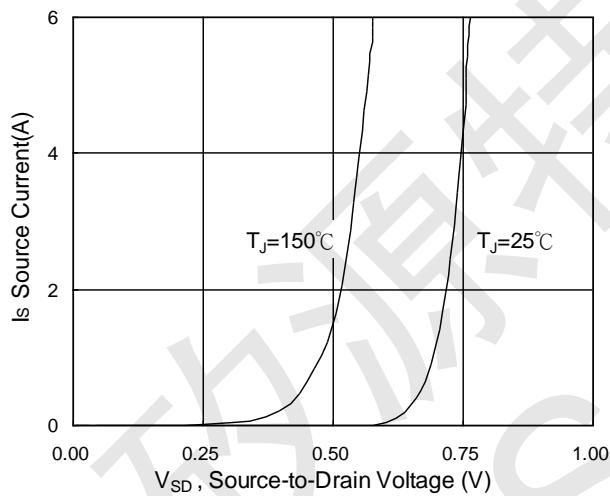


Fig.3 Forward Characteristics of Reverse

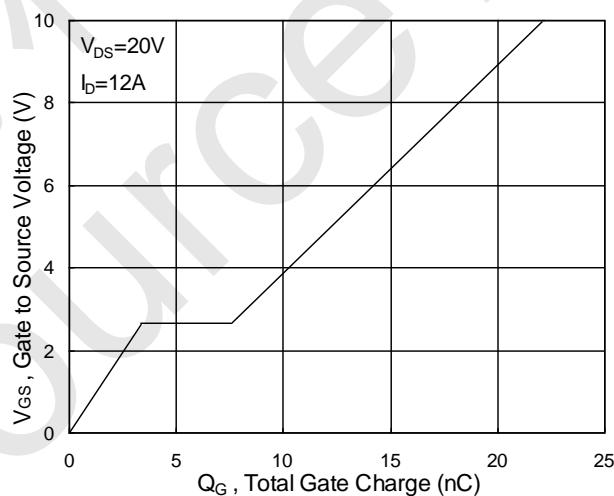


Fig.4 Gate-Charge Characteristics

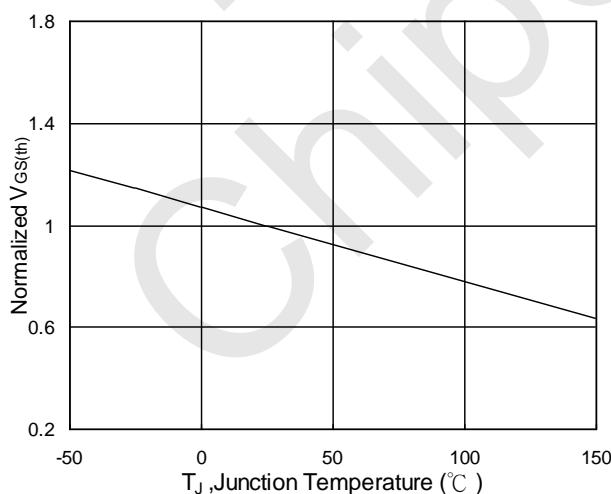


Fig.5  $V_{GS(th)}$  vs.  $T_J$

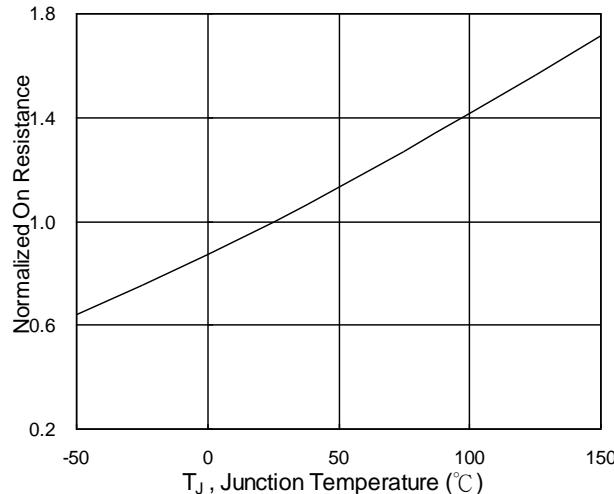


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$



CST4030 N-Ch and P-Ch Fast Switching MOSFETs

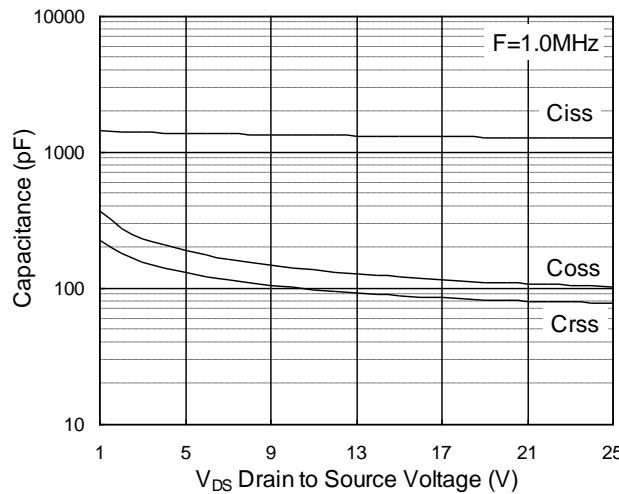


Fig.7 Capacitance

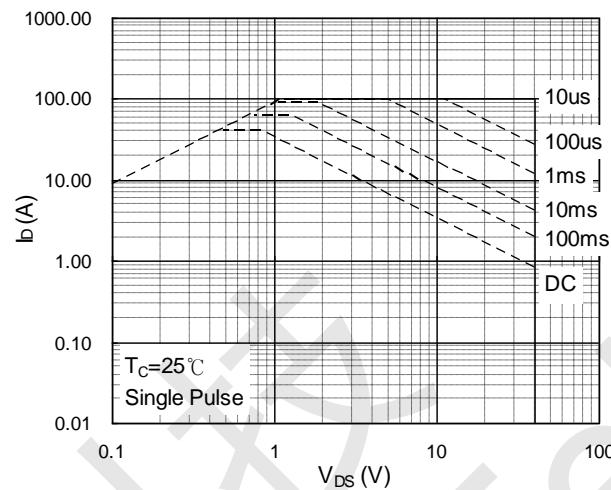


Fig.8 Safe Operating Area

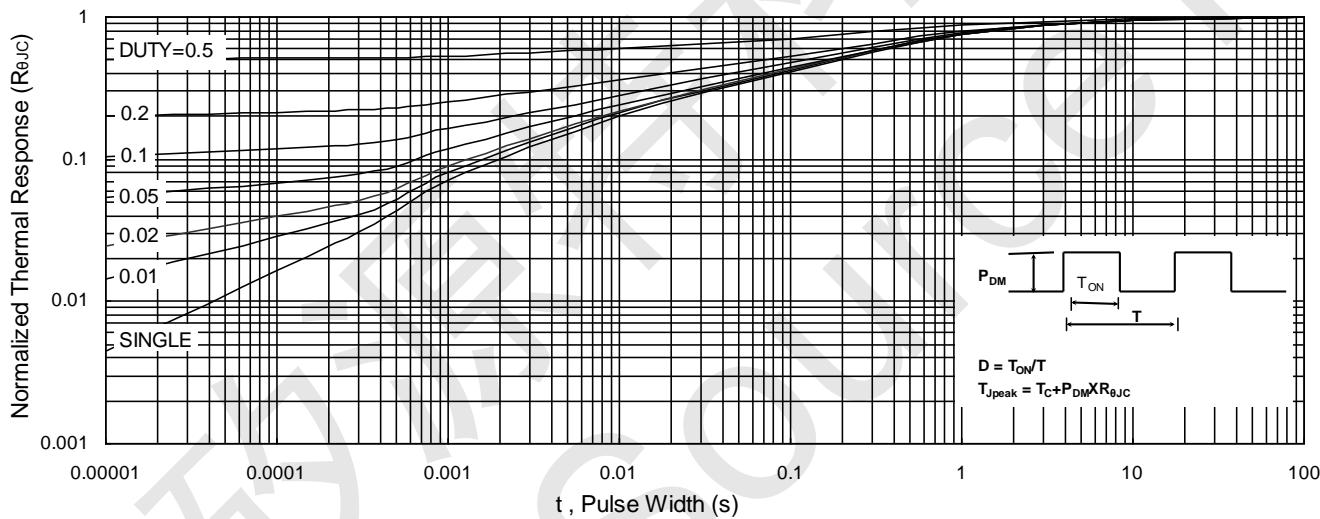


Fig.9 Normalized Maximum Transient Thermal Impedance

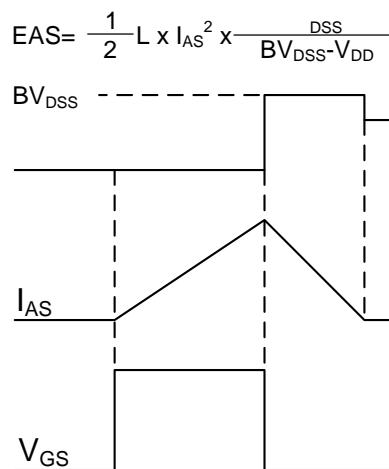
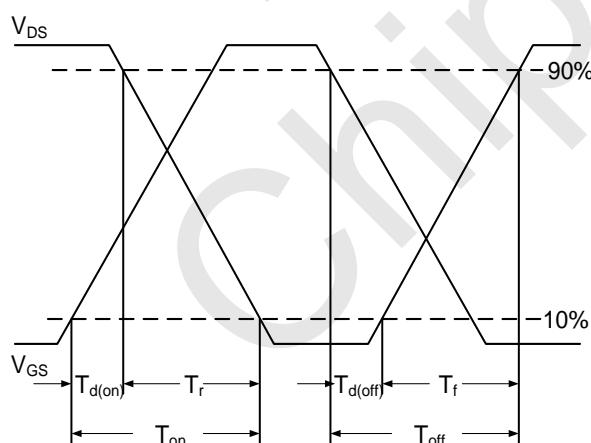


Fig.11 Unclamped Inductive Switching Waveform



CST4030 N-Ch and P-Ch Fast Switching MOSFETs

P-Channel Typical Characteristics

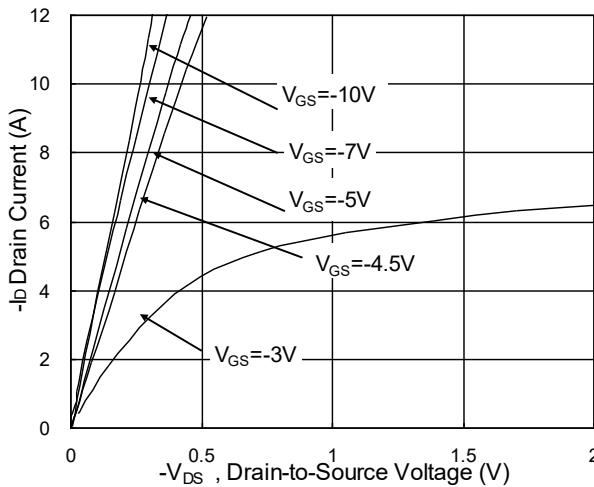


Fig.1 Typical Output Characteristics

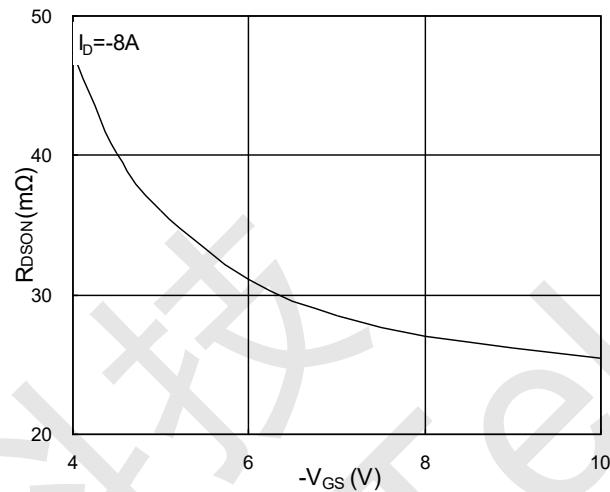


Fig.2 On-Resistance v.s Gate-Source

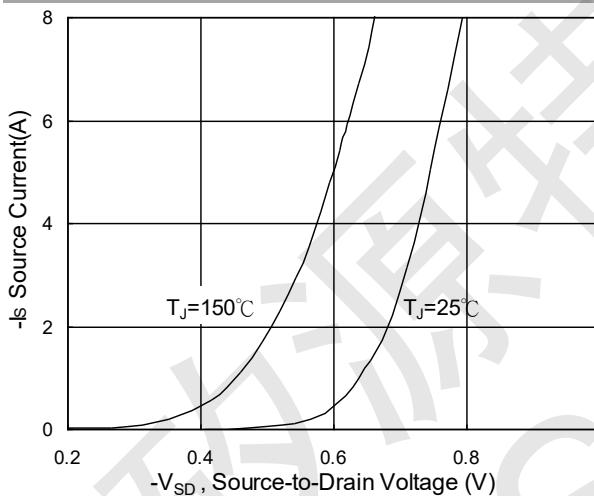


Fig.3 Forward Characteristics Of Reverse

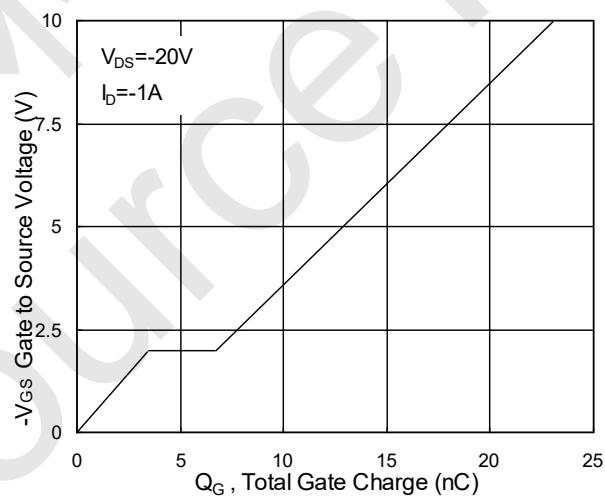


Fig.4 Gate Charge Characteristics

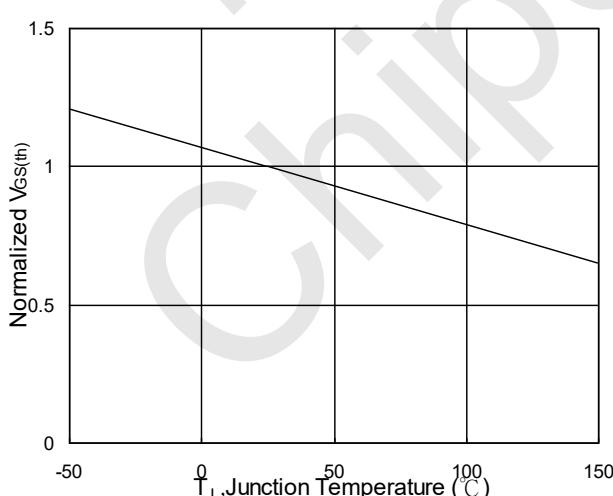


Fig.5 Normalized  $V_{GS(th)}$  v.s  $T_J$

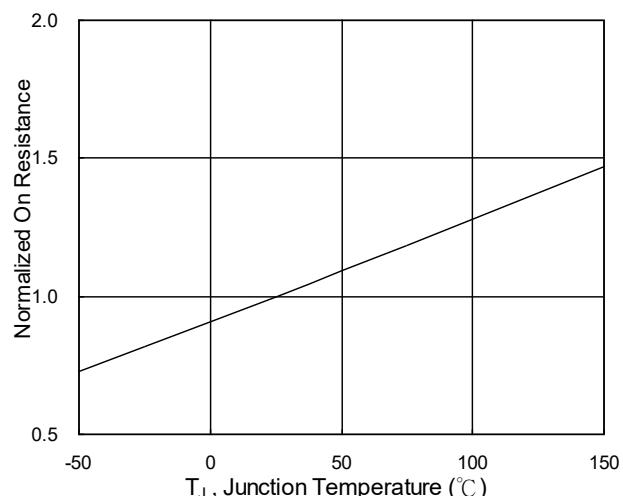


Fig.6 Normalized  $R_{DS(on)}$  v.s  $T_J$



CST4030 N-Ch and P-Ch Fast Switching MOSFETs

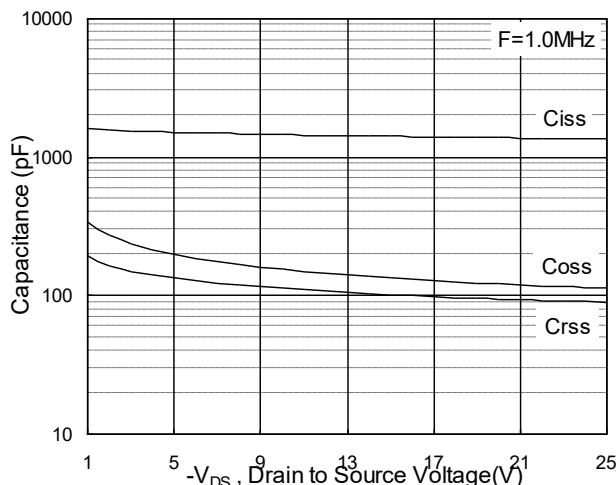


Fig.7 Capacitance

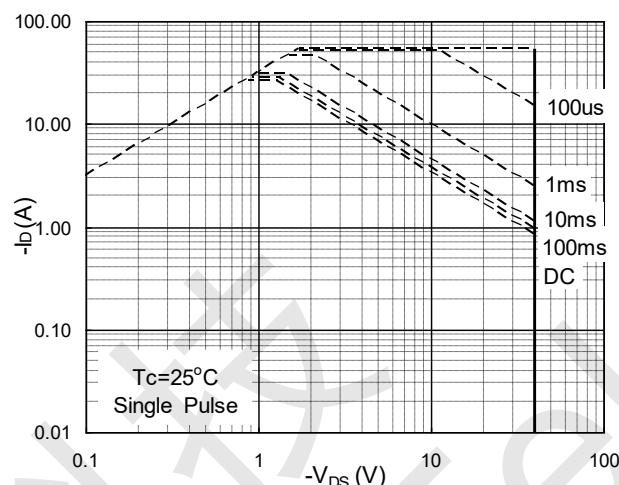


Fig.8 Safe Operating Area

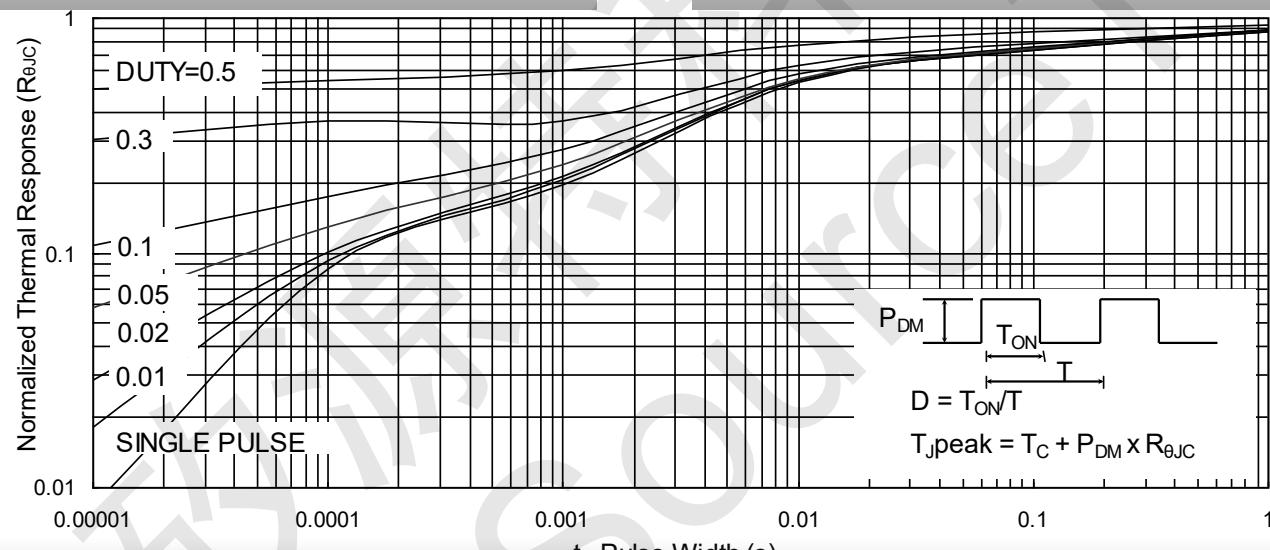


Fig.9 Normalized Maximum Transient Thermal Impedance

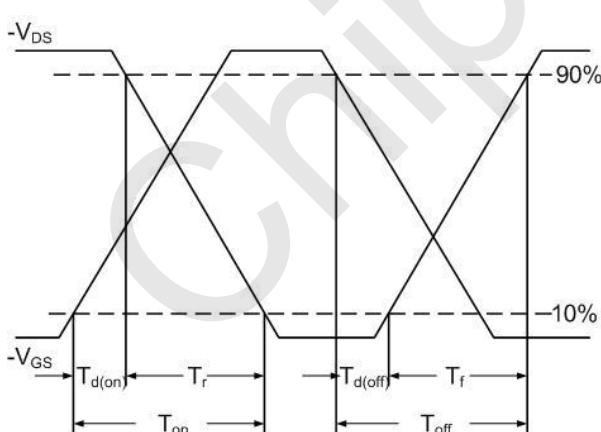


Fig.10 Switching Time Waveform

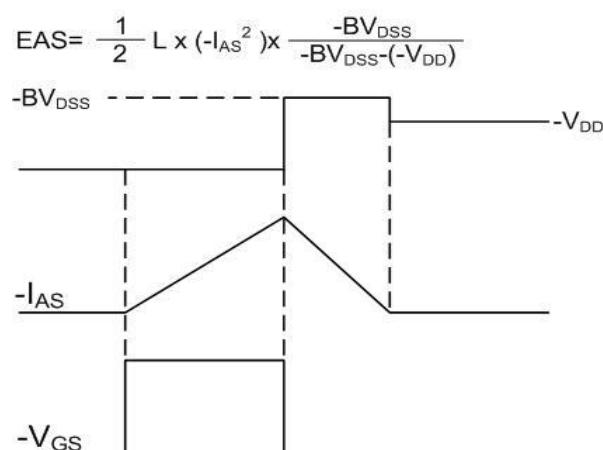
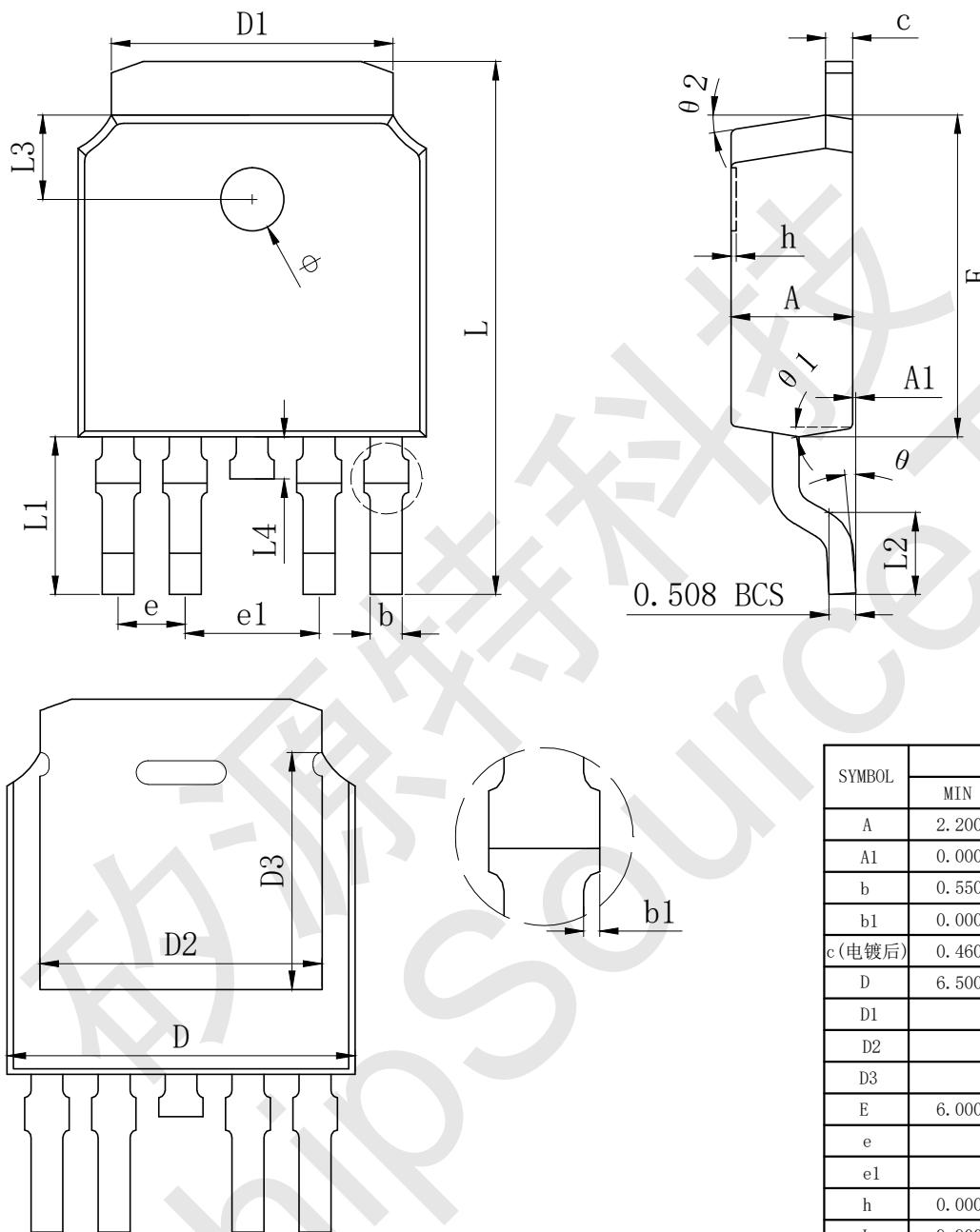


Fig.11 Unclamped Inductive Waveform



CST4030 N-Ch and P-Ch Fast Switching MOSFETs

CST4030 Mechanical Dimensions for TO-252-4L



| SYMBOL  | MILLIMETER |        |        |
|---------|------------|--------|--------|
|         | MIN        | Typ.   | MAX    |
| A       | 2.200      | 2.300  | 2.400  |
| A1      | 0.000      |        | 0.127  |
| b       | 0.550      | 0.600  | 0.650  |
| b1      | 0.000      |        | 0.120  |
| c (电镀后) | 0.460      | 0.520  | 0.580  |
| D       | 6.500      | 6.600  | 6.700  |
| D1      | 5.334 REF  |        |        |
| D2      | 5.346 REF  |        |        |
| D3      | 4.490 REF  |        |        |
| E       | 6.000      | 6.100  | 6.200  |
| e       | 1.270 TYP  |        |        |
| e1      | 2.540 TYP  |        |        |
| h       | 0.000      | 0.100  | 0.200  |
| L       | 9.900      | 10.100 | 10.300 |
| L1      | 2.988 REF  |        |        |
| L2      | 1.400      | 1.550  | 1.700  |
| L3      | 1.600 REF  |        |        |
| L4      | 0.700      | 0.800  | 0.900  |
| φ       | 1.100      | 1.200  | 1.300  |
| θ       | 0°         |        | 8°     |
| θ1      | 9° TYP     |        |        |
| θ2      | 9° TYP     |        |        |